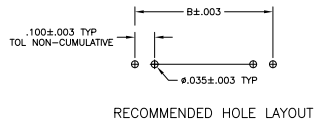
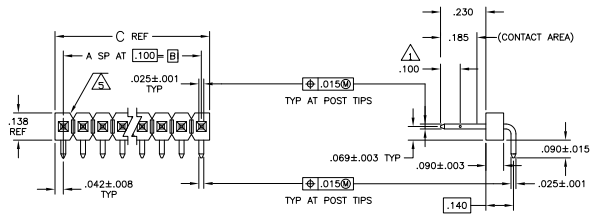


REV	DATE	DESCRIPTION	BY	CHK
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01		REVISED PER EDD-11-004820	11MMR11	RK HMR



- △ POINT OF MEASUREMENT FOR PLATING THICKNESS
- 2. ASSEMBLY MAY BE BROKEN TO THE DESIRED NUMBER OF POSITIONS.
- 3. TRUE POSITION TOLERANCE OF THE POST TIPS APPLIES WHEN THE HEADERS ARE HELD FLAT AGAINST THE PRINTED CIRCUIT BOARD
- △ .000030 GOLD IN CONTACT AREA, .000100-.000200 MATTE TIN-LEAD ON SOLDER TAIL, ALL OVER .000050 NICKEL
- △ BREAKAWAY NOTCH ANGLE CAN BE ORIENTED TO THE RIGHT (AS SHOWN) OR TO THE LEFT
- △ .000030 GOLD IN CONTACT AREA, .000100-.000200 MATTE TIN ON SOLDER TAIL, ALL OVER .000050 NICKEL
- △ HIGH TEMPERATURE CONFIGURATION
- △ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

REV	DATE	DESCRIPTION	BY	CHK
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REMARKS	PLATING	C	B	A	NO OF POS	ASSEMBLY PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT. BY: D. SINICLI, CHECKED: J. BUCKLER, DRAWN: J. BUCKLER, DATE: 11/11/03

TE Connectivity

ASSEMBLY, MOD II, HEADER, BREAKAWAY, SINGLE ROW, RIGHT ANGLE 100, WITH .025 SQUARE POSTS

SIZE: A1, DATE: 11/11/03, DRAWING NO: 100779, REV: 1, SHEET: 1 OF 1, PART NO: 103765